

# PHOTOCOUPLER

## PS2505-1,-2,-4,PS2505L-1,-2,-4

### HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE MULTI PHOTOCOUPLER SERIES

–NEPOC Series–

#### DESCRIPTION

The PS2505-1, -2, -4 and PS2505L-1, -2, -4 are optically coupled isolators containing GaAs light emitting diodes and an NPN silicon phototransistor.

The PS2505-1, -2, -4 are in a plastic DIP (Dual In-line Package) and the PS2505L-1, -2, -4 are lead bending type (Gull-wing) for surface mount.

#### FEATURES

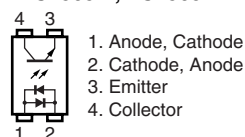
- AC input response
- High isolation voltage ( $BV = 5\,000\text{ V r.m.s.}$ )
- High collector to emitter voltage ( $V_{CEO} = 80\text{ V}$ )
- High-speed switching ( $t_r = 3\text{ }\mu\text{s TYP.}$ ,  $t_f = 5\text{ }\mu\text{s TYP.}$ )
- Ordering number of tape product: PS2505L-1-E3, E4, F3, F4, PS2505L-2-E3, E4
- Safety standards
  - UL approved: File No. E72422

#### APPLICATIONS

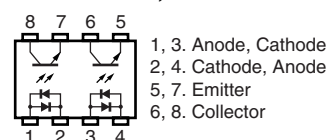
- Power supply
- Telephone/FAX.
- FA/OA equipment
- Programmable logic controller

#### PIN CONNECTION (Top View)

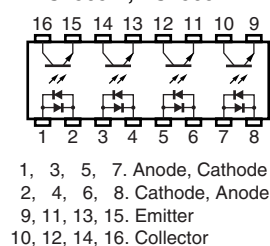
##### PS2505-1, PS2505L-1



##### PS2505-2, PS2505L-2



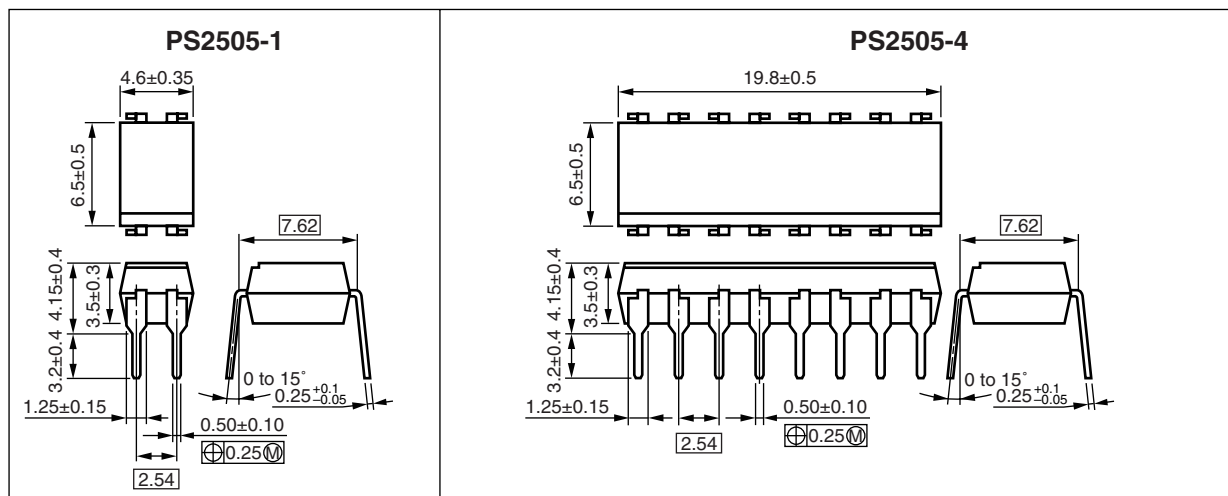
##### PS2505-4, PS2505L-4



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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

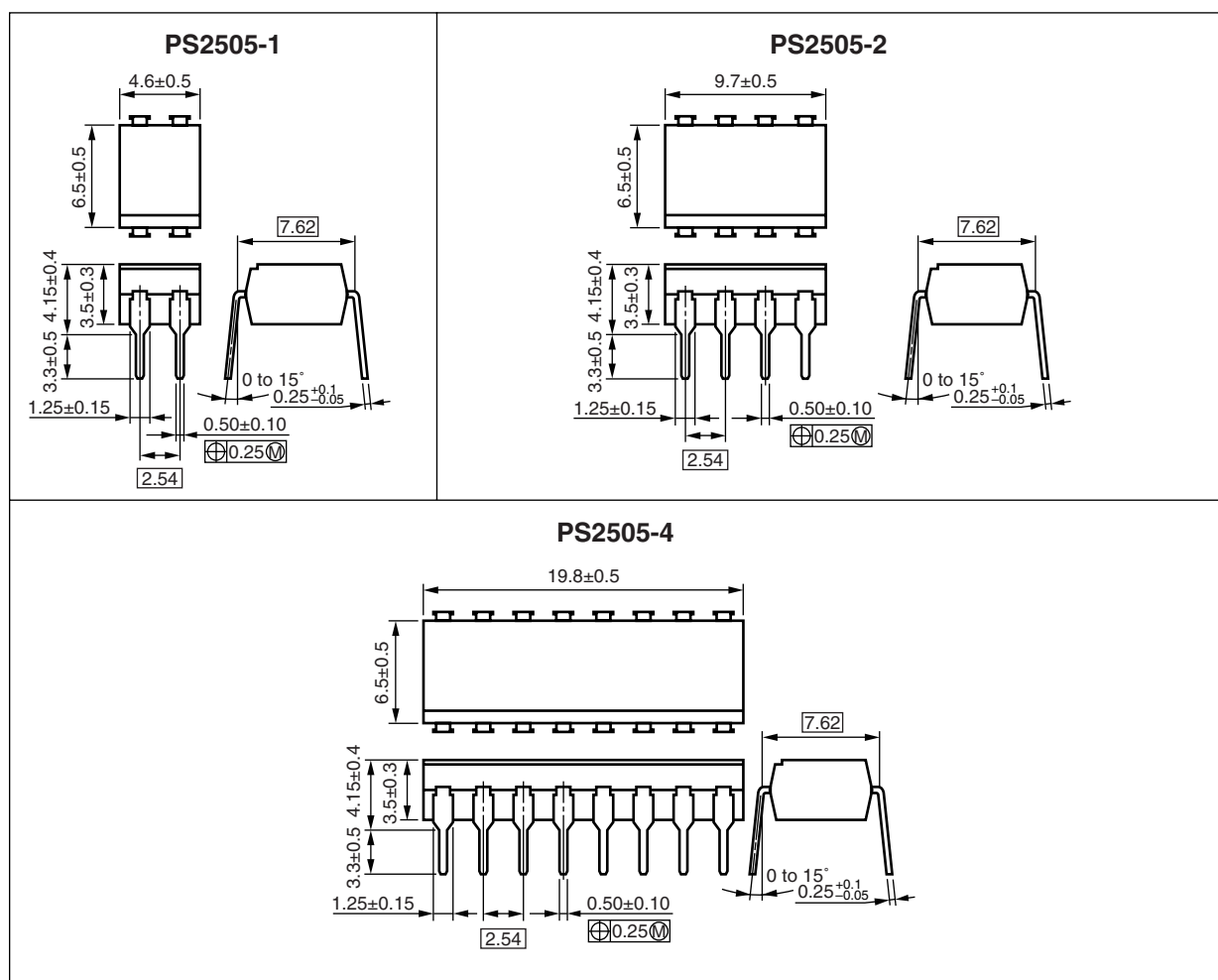
PACKAGE DIMENSIONS (UNIT : mm)

DIP Type (New package)

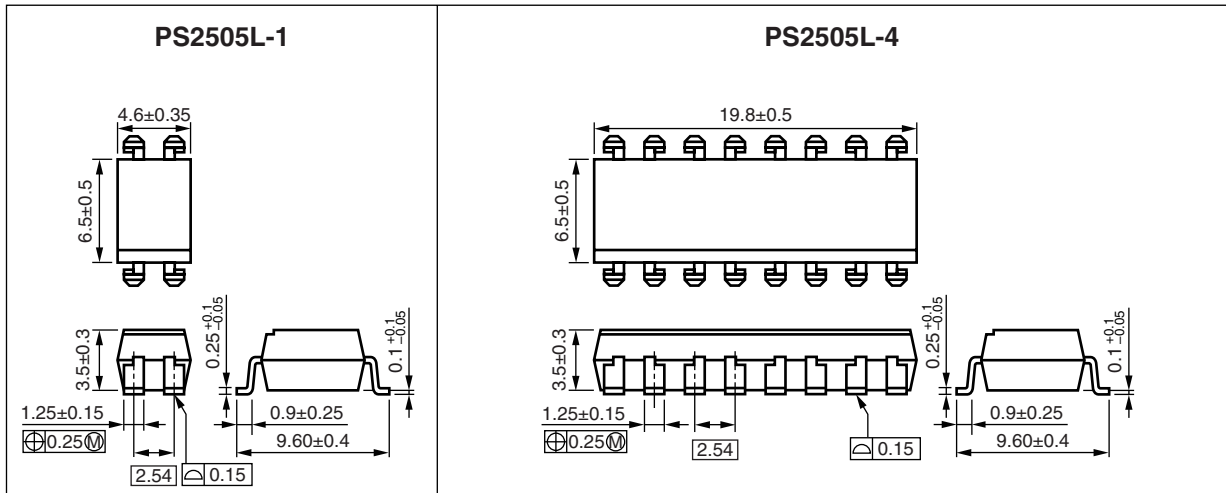


Caution New package 1-ch, 4-ch only

DIP Type

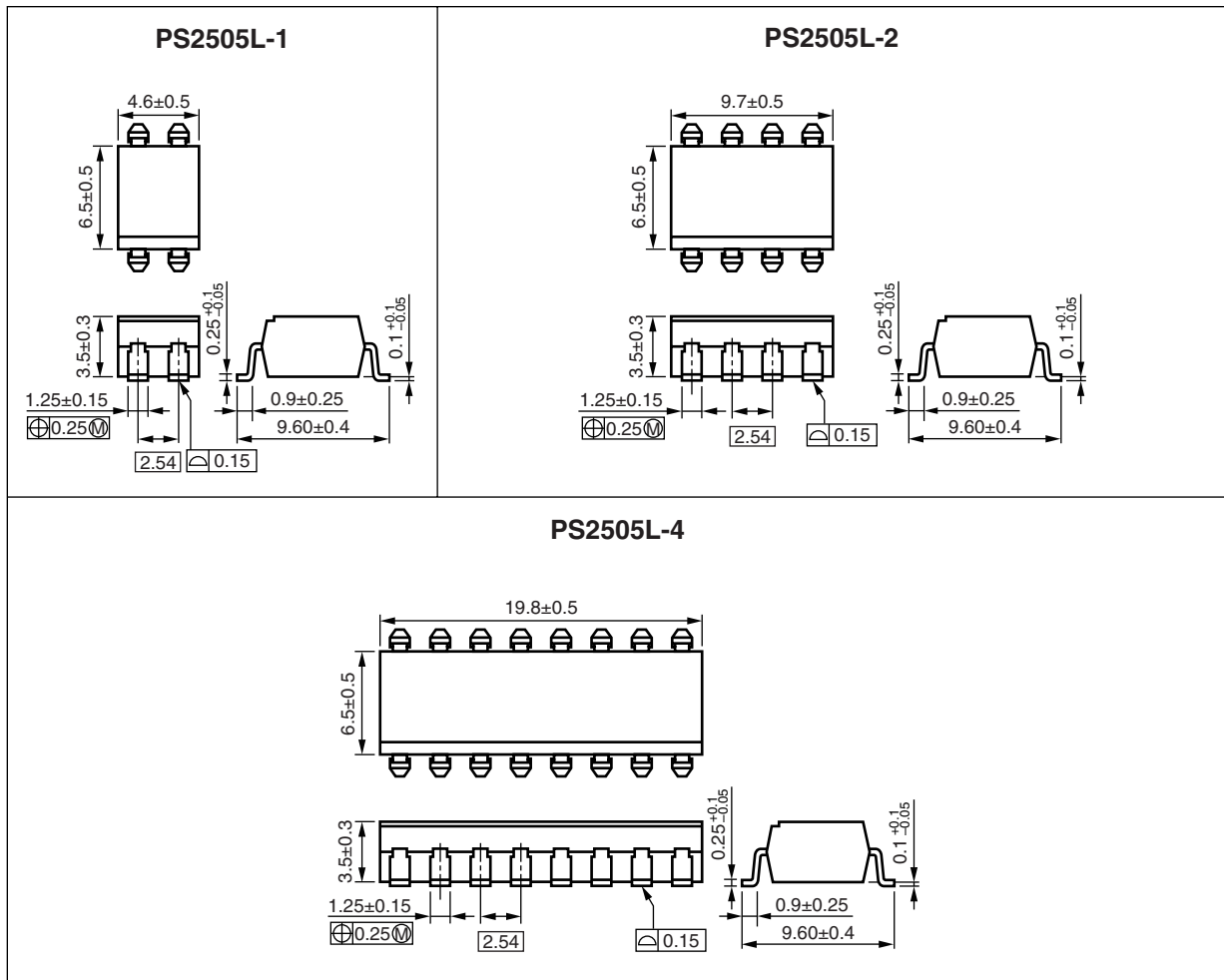


Lead Bending Type (New package)



Caution New package 1-ch, 4-ch only

Lead Bending Type



★ MARKING EXAMPLE

PS2505-1

No. 1 pin Mark

NEC  
2505  
NL601

Assembly Lot

N

L

6

01

Week Assembled  
Year Assembled  
(Last 1 Digit)

In-house Code

CTR Rank Code

|              |               |                |
|--------------|---------------|----------------|
| Package      | Made in Japan | Made in Taiwan |
| Standard PKG | L             | N              |
| New PKG      | J             | K              |

PS2505-2, -4

No. 1 pin Mark

NEC  
PS2505-2  
NL601

Country Assembled

Type Number

Assembly Lot

N

L

6

01

Week Assembled  
Year Assembled  
(Last 1 Digit)

In-house Code

CTR Rank Code

|              |                 |                |
|--------------|-----------------|----------------|
| Package      | Made in Japan   | Made in Taiwan |
| Standard PKG | L               | N              |
| New PKG      | J <sup>*1</sup> |                |

\*1 PS2505-4 only

★ ORDERING INFORMATION

| Part Number  | Order Number   | Solder Plating Specification | Packing Style                | Safety Standard Approval           | Application Part Number <sup>*1</sup> |
|--------------|----------------|------------------------------|------------------------------|------------------------------------|---------------------------------------|
| PS2505-1     | PS2505-1-A     | Pb-Free                      | Magazine case 100 pcs        | Standard products<br>(UL Approved) | PS2505-1                              |
| PS2505L-1    | PS2505L-1-A    |                              |                              |                                    |                                       |
| PS2505L-1-E3 | PS2505L-1-E3-A |                              | Embossed Tape 1 000 pcs/reel |                                    |                                       |
| PS2505L-1-E4 | PS2505L-1-E4-A |                              |                              |                                    |                                       |
| PS2505L-1-F3 | PS2505L-1-F3-A |                              | Embossed Tape 2 000 pcs/reel |                                    |                                       |
| PS2505L-1-F4 | PS2505L-1-F4-A |                              |                              |                                    |                                       |
| PS2505-2     | PS2505-2-A     |                              | Magazine case 45 pcs         |                                    | PS2505-2                              |
| PS2505L-2    | PS2505L-2-A    |                              |                              |                                    |                                       |
| PS2505L-2-E3 | PS2505L-2-E3-A |                              | Embossed Tape 1 000 pcs/reel |                                    |                                       |
| PS2505L-2-E4 | PS2505L-2-E4-A |                              |                              |                                    | PS2505-4                              |
| PS2505-4     | PS2505-4-A     |                              | Magazine case 20 pcs         |                                    |                                       |
| PS2505L-4    | PS2505L-4-A    |                              |                              |                                    |                                       |

\*1 For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)**

| Parameter                       |                                    | Symbol              | Ratings                |                             | Unit    |
|---------------------------------|------------------------------------|---------------------|------------------------|-----------------------------|---------|
|                                 |                                    |                     | PS2505-1,<br>PS2505L-1 | PS2505-2,-4<br>PS2505L-2,-4 |         |
| Diode                           | Forward Current (DC)               | I <sub>F</sub>      | ±80                    |                             | mA/ch   |
|                                 | Power Dissipation Derating         | ΔP <sub>D</sub> /°C | 1.5                    | 1.2                         | mW/°C   |
|                                 | Power Dissipation                  | P <sub>D</sub>      | 150                    | 120                         | mW/ch   |
|                                 | Peak Forward Current <sup>*1</sup> | I <sub>FP</sub>     | ±1                     |                             | A/ch    |
| Transistor                      | Collector to Emitter Voltage       | V <sub>CEO</sub>    | 80                     |                             | V       |
|                                 | Emitter to Collector Voltage       | V <sub>ECO</sub>    | 7                      |                             | V       |
|                                 | Collector Current                  | I <sub>C</sub>      | 50                     |                             | mA/ch   |
|                                 | Power Dissipation Derating         | ΔP <sub>C</sub> /°C | 1.5                    | 1.2                         | mW/°C   |
|                                 | Power Dissipation                  | P <sub>C</sub>      | 150                    | 120                         | mW/ch   |
| Isolation Voltage <sup>*2</sup> |                                    | BV                  | 5 000                  |                             | Vr.m.s. |
| Operating Ambient Temperature   |                                    | T <sub>A</sub>      | -55 to +100            |                             | °C      |
| Storage Temperature             |                                    | T <sub>stg</sub>    | -55 to +150            |                             | °C      |

\*1 PW = 100 μs, Duty Cycle = 1%

\*2 AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output

Pins 1-2 shorted together, 3-4 shorted together (PS2505-1, PS2505L-1).

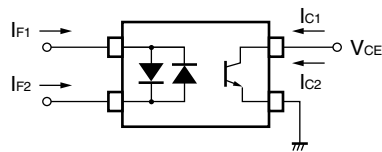
Pins 1-4 shorted together, 5-8 shorted together (PS2505-2, PS2505L-2).

Pins 1-8 shorted together, 9-16 shorted together (PS2505-4, PS2505L-4).

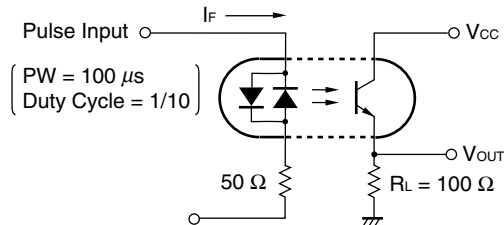
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**

| Parameter  |  | Symbol               | Conditions  | MIN.             | TYP. | MAX. | Unit |
|------------|--|----------------------|---|------------------|------|------|------|
| Diode      | Forward Voltage  | V <sub>F</sub>       | I <sub>F</sub> = ±10 mA   |                  | 1.17 | 1.4  | V    |
|            | Terminal Capacitance                                     | C <sub>t</sub>       | V = 0 V, f = 1.0 MHz  |                  | 100  |      | pF   |
| Transistor | Collector to Emitter Dark Current                        | I <sub>CEO</sub>     | V <sub>CE</sub> = 80 V, I <sub>F</sub> = 0 mA                         |                  |      | 100  | nA   |
| Coupled    | Current Transfer Ratio (I <sub>C</sub> /I <sub>F</sub> ) | CTR                  | I <sub>F</sub> = ±5 mA, V <sub>CE</sub> = 5 V                         | 80               | 300  | 600  | %    |
|            | CTR Ratio <sup>*1</sup>                                  | CTR1/<br>CTR2        | I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V                          | 0.3              | 1.0  | 3.0  |      |
|            | Collector Saturation Voltage                             | V <sub>CE(sat)</sub> | I <sub>F</sub> = ±10 mA, I <sub>C</sub> = 2 mA                        |                  |      | 0.3  | V    |
|            | Isolation Resistance                                     | R <sub>I-O</sub>     | V <sub>I-O</sub> = 1.0 kV <sub>DC</sub>                               | 10 <sup>11</sup> |      |      | Ω    |
|            | Isolation Capacitance                                    | C <sub>I-O</sub>     | V = 0 V, f = 1.0 MHz  |                  | 0.5  |      | pF   |
|            | Rise Time <sup>*2</sup>                                  | t <sub>r</sub>       | V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA, R <sub>L</sub> = 100 Ω |                  | 3    |      | μs   |
|            | Fall Time <sup>*2</sup>                                  | t <sub>f</sub>       |   |                  | 5    |      |      |

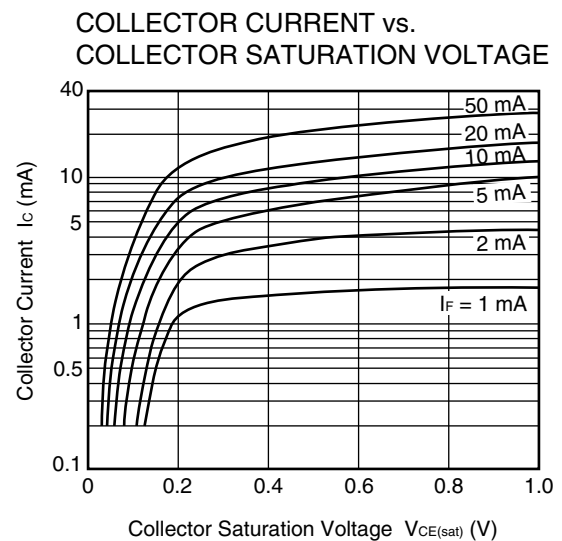
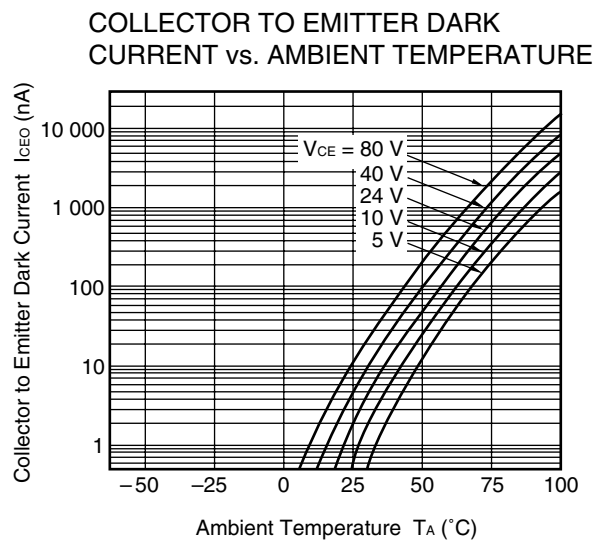
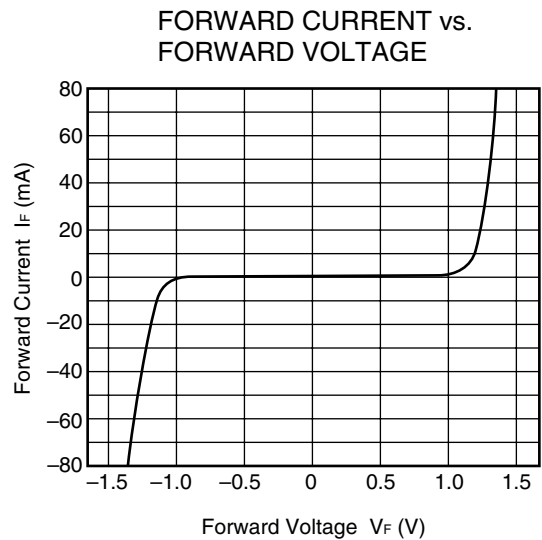
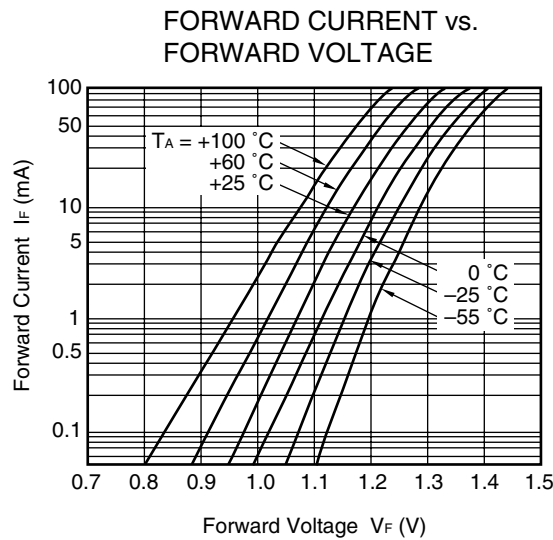
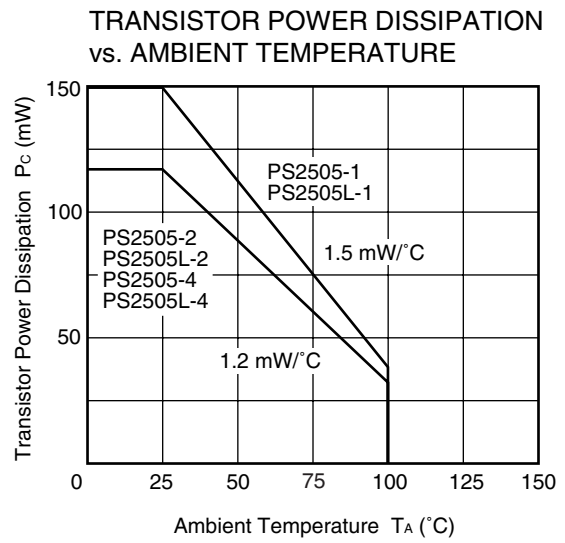
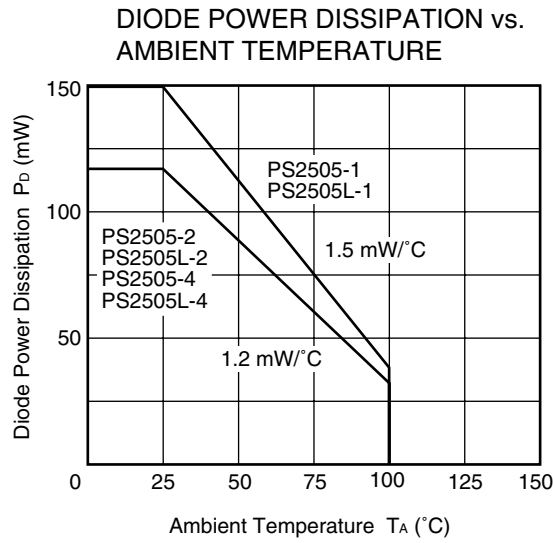
**\*1** CTR1 = I<sub>C1</sub>/I<sub>F1</sub>, CTR2 = I<sub>C2</sub>/I<sub>F2</sub>



**\*2** Test circuit for switching time

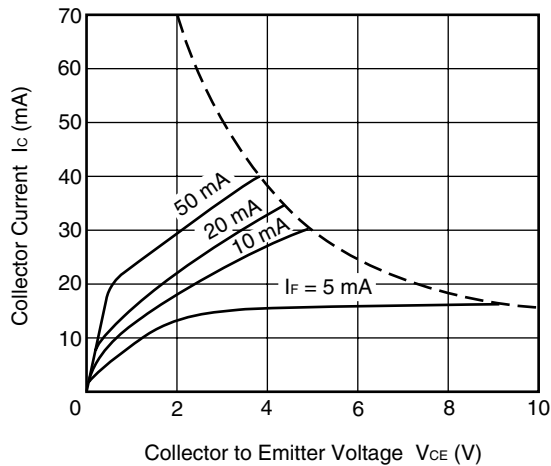


**TYPICAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)**

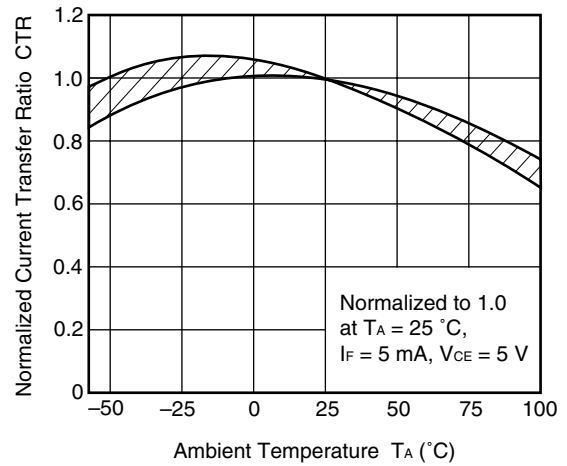


**Remark** The graphs indicate nominal characteristics.

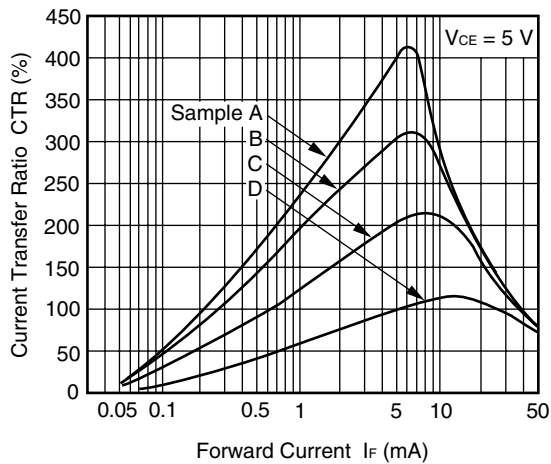
COLLECTOR CURRENT vs.  
COLLECTOR TO EMITTER VOLTAGE



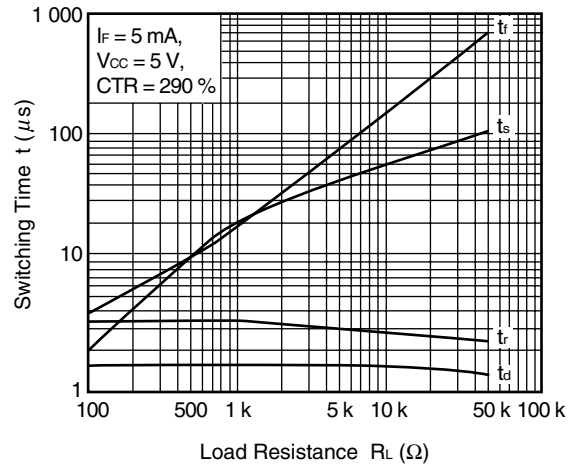
NORMALIZED CURRENT TRANSFER  
RATIO vs. AMBIENT TEMPERATURE



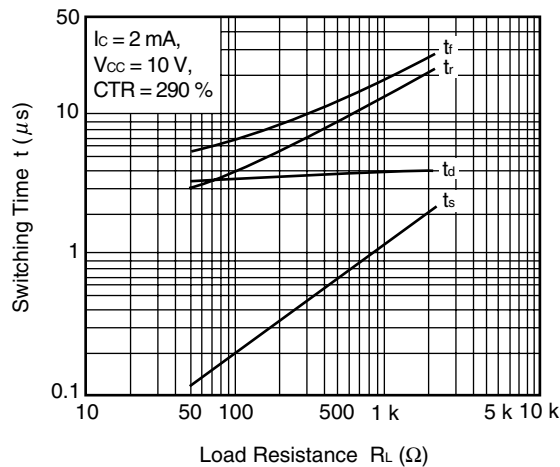
CURRENT TRANSFER RATIO vs.  
FORWARD CURRENT



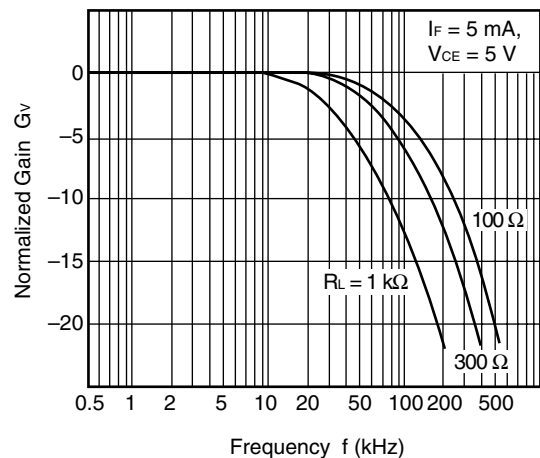
SWITCHING TIME vs.  
LOAD RESISTANCE



SWITCHING TIME vs.  
LOAD RESISTANCE

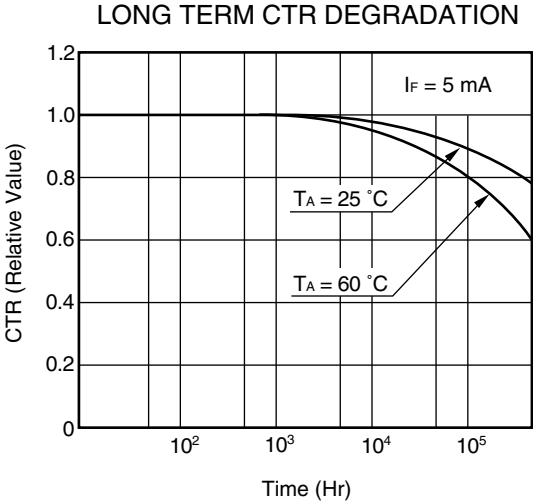


FREQUENCY RESPONSE



**Remark** The graphs indicate nominal characteristics.

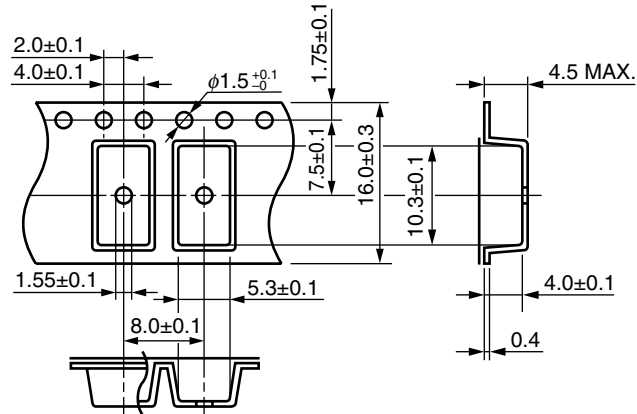




**Remark** The graph indicates nominal characteristics.

TAPING SPECIFICATIONS (UNIT : mm)

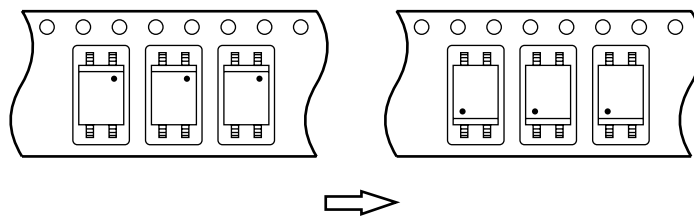
Outline and Dimensions (Tape)



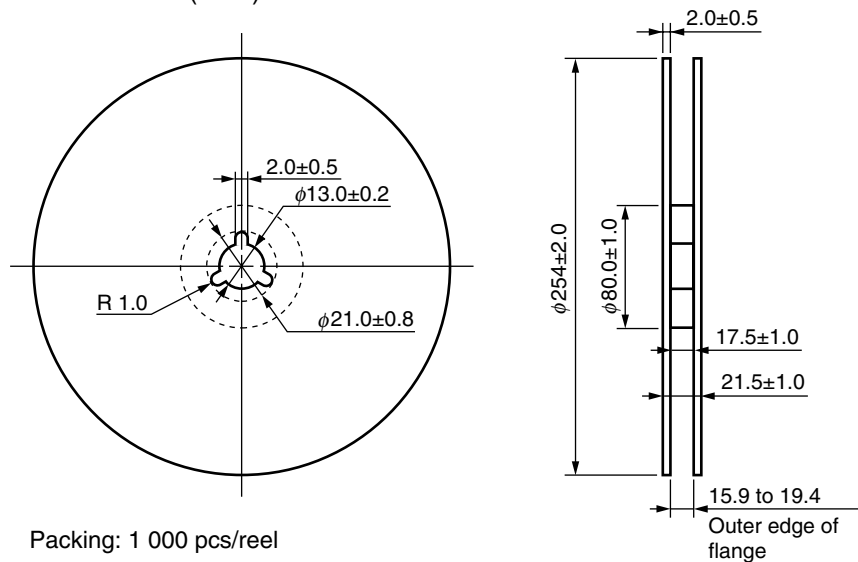
Tape Direction

PS2505L-1-E3

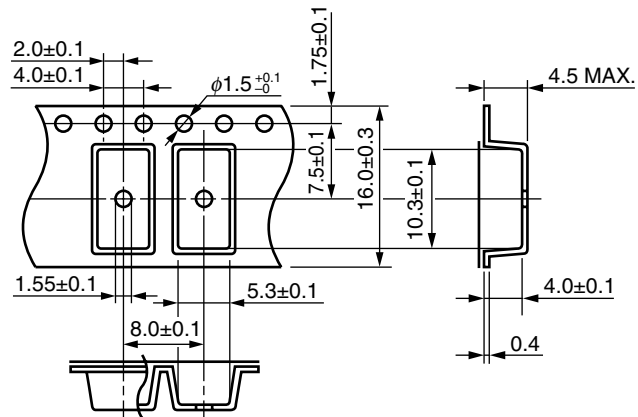
PS2505L-1-E4



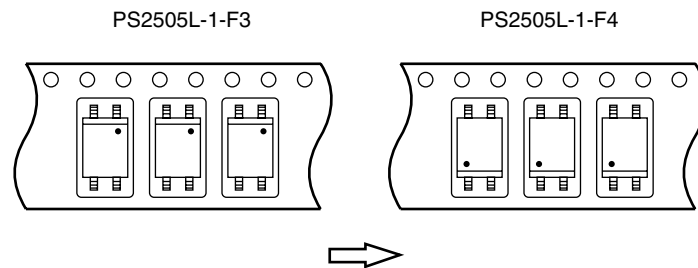
Outline and Dimensions (Reel)



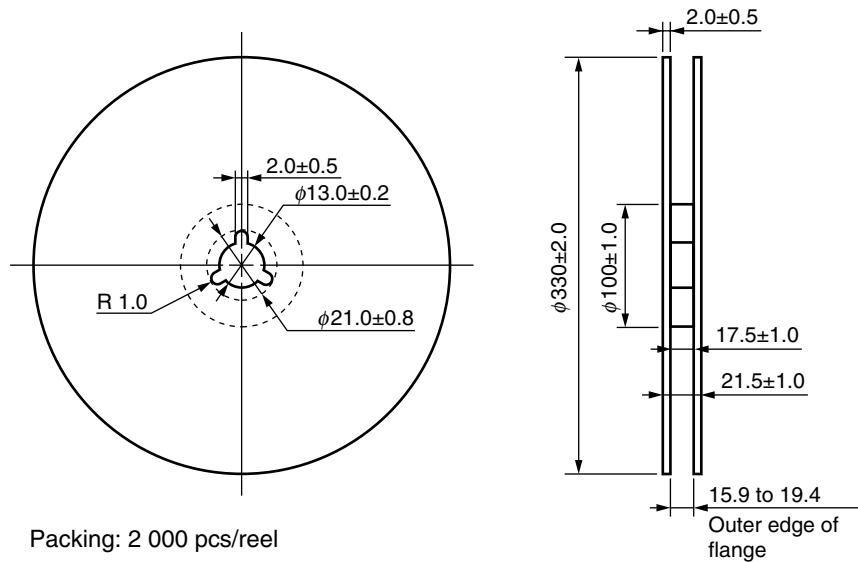
Outline and Dimensions (Tape)



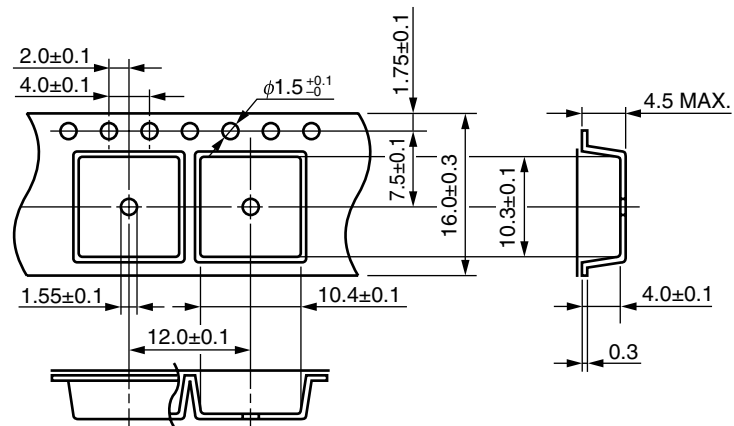
Tape Direction



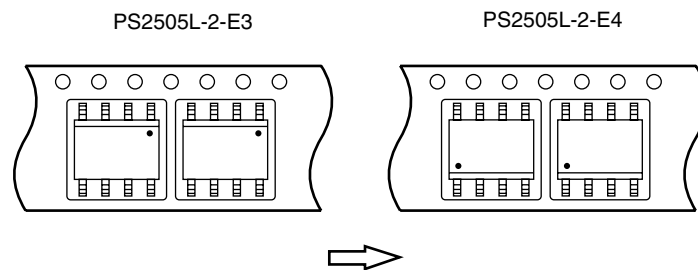
Outline and Dimensions (Reel)



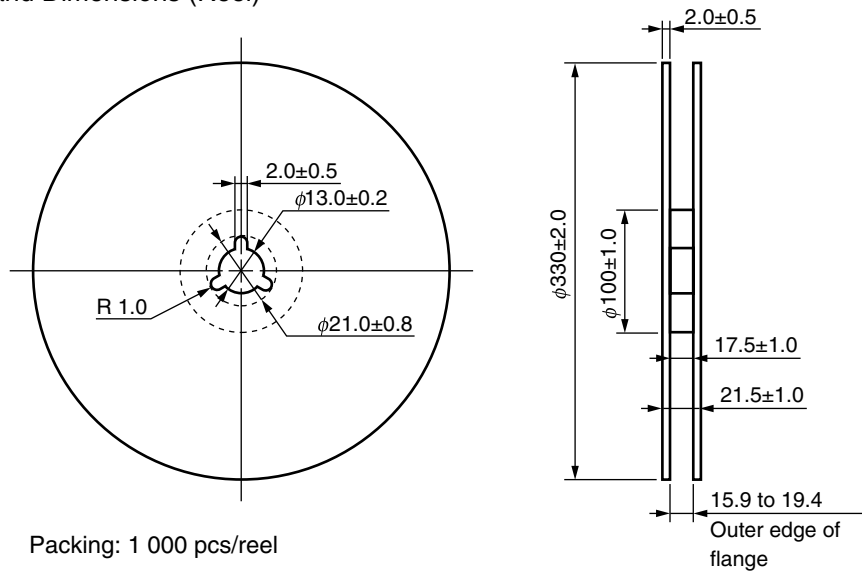
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



Packing: 1 000 pcs/reel

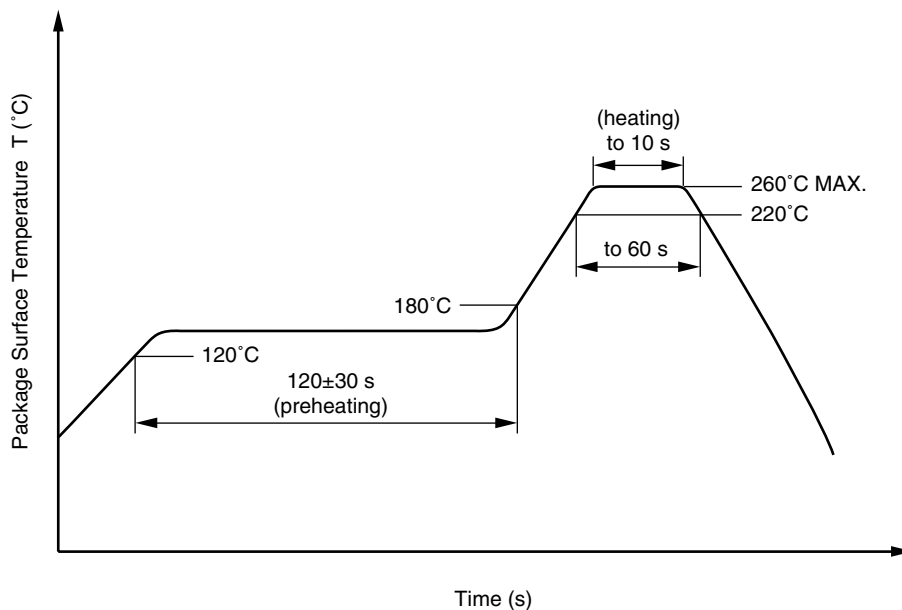
## NOTES ON HANDLING

### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### ★ (3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

**(4) Cautions**

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

**2. Cautions regarding noise**

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ **3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler**

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below  $I_F = 1 \text{ mA}$ .

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

**USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

|                    |               |   |
|--------------------|---------------|---|
| <div>Caution</div> | GaAs Products | <p>This product uses gallium arsenide (GaAs).<br/>GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> <li>• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.</li> </ul> <ol style="list-style-type: none"> <li>1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> <li>2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li> </ol> <ul style="list-style-type: none"> <li>• Do not burn, destroy, cut, crush, or chemically dissolve the product.</li> <li>• Do not lick the product or in any way allow it to enter the mouth.</li> </ul> |
|--------------------|---------------|---|

► For further information, please contact

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